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MOTOROLA SEMICONDUCTOR I TECHNICAL DATA

MC68HC05P4 MC68HCL05P4 MC68HSC05P4

Addendum to MC68HC05P4 HCMOS Microcontroller Unit Technical Data

This addendum supplements *MC68HC05P4 Technical Data* (Motorola document number MC68HC05P4/D) with the following additional information:

- DC Electrical Characteristics
- MC68HCL05P4 data APPENDIX A contains data for the MC68HCL05P4, a low-power version of the MC68HC05P4
- MC68HSC05P4 data APPENDIX B contains data for the MC68HSC05P4, a high-speed version of the MC68HC05P4

Specifications and information herein are subject to change without notice.

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9.4 DC ELECTRICAL CHARACTERISTICS

The following table replaces Table 9-3 in MC68HC05P4 Technical Data.

Characteristic	Symbol	Min	Typ ⁽¹⁾	Max	Unit
Output Voltage $I_{LOAD} = 10.0 \ \mu A$ $I_{LOAD} = -10.0 \ \mu A$	V _{ol} V _{oн}	 V _{DD} - 0.1	_	0.1	V V
Output High Voltage (I _{LOAD} = -0.8 mA) PA7–PA0, PB7–PB5, PC7–PC0, PD5, TCMP	V _{OH}	V _{DD} - 0.8	_	_	V
Output Low Voltage (I _{LOAD} = 1.6 mA) PA7–PA0, PB7–PB5, PC7–PC0, PD5, TCMP	V _{OL}	_	_	0.4	v
Input High Voltage PA7–PA0, PB7–PB5, PC7–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1	V _{IH}	$0.7 \times V_{DD}$	_	V _{DD}	v
Input Low Voltage PA7–PA0, PB7–PB5, PC7–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1	V _{IL}	V _{ss}	_	$0.2 \times V_{DD}$	v
Data-Retention Mode Supply Voltage	V _{RM}	2	_	_	V
Supply Current Run ⁽²⁾ WAIT ⁽³⁾ STOP ⁽⁴⁾ 25 C 0 to 70 C (Standard)	I _{DD}	 	3.1 1.1 2.25 —	7.0 4.0 50 140	mA mA µA µA
I/O Ports High-Z Leakage Current PA7–PA0, PB7–PB5, PC7–PC0, PD5	IIL			10	µA
Input Current RESET, IRQ, OSC1, PD7/TCAP	I _{IN}	_	_	1	βų
Capacitance Ports (Input or Output) RESET, IRQ, PD5, PD7/TCAP	C _{OUT} C _{IN}		_	12 8	pF pF

Table 9-3	. DC Electrical	Characteristics	$(V_{DD} = 5.0 Vdc)$	10%)
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1. Typical values at midpoint of voltage range, 25 C only.

1. Typical values at midpoint of voltage range, 25 °C only. 2. Run (operating) I_{DD} measured using external square wave clock source ($f_{OSC} = 4.2$ MHz). All inputs 0.2 V from rail. No dc loads. Less than 50 pF on all outputs. $C_L = 20$ pF on OSC2. 3. WAIT I_{DD} measured using external square wave clock source ($f_{OSC} = 4.2$ MHz). All inputs 0.2 V from rail. No dc loads. Less than 50 pF on all outputs. CL = 20 pF on OSC2. All ports configured as inputs. $V_{IL} = 0.2$ V. $V_{IH} = V_{DD} - 0.2$ V. OSC2 capacitance linearly affects WAIT I_{DD} . 4. STOP I_{DD} measured with OSC1 = V_{SS} . All ports configured as inputs. $V_{IL} = 0.2$ V. $V_{IH} = V_{DD} - 0.2$ V.

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The following table replaces Table 9-4 in MC68HC05P4 Technical Data.

Characteristic	Symbol	Min	Typ ⁽¹⁾	Max	Unit		
Output Voltage I _{LOAD} = 10.0 µA I _{LOAD} = -10.0 µA	V _{ol} V _{oн}	 V _{DD} - 0.1		0.1	V V		
Output High Voltage (I _{LOAD} = -0.2 mA) PA7–PA0, PB7–PB5, PC7–PC0, PD5, TCMP	V _{OH}	V _{DD} - 0.3	_	_	V		
Output Low Voltage (I _{LOAD} = 0.4 mA) PA7–PA0, PB7–PB5, PC7–PC0, PD5, TCMP	V _{OL}	_	_	0.3	V		
Input High Voltage PA7–PA0, PB7–PB5, PC7–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1	V _{IH}	$0.7 \times V_{DD}$		V _{DD}	V		
Input Low Voltage PA7–PA0, PB7–PB5, PC7–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1	V _{IL}	V _{ss}	_	$0.2 \times V_{DD}$	V		
Supply Current Run ⁽²⁾ WAIT ⁽³⁾ STOP ⁽⁴⁾	I _{DD}		0.8 0.35	2.5 1.4	mA mA		
25 C 0 to 70 C (Standard)		_	0.6	30 80	μΑ μΑ		
I/O Ports High-Z Leakage Current PA7–PA0, PB7–PB5, PC7–PC0, PD5	I _{IL}	_	_	10	Ą		
Input Current RESET, IRQ, OSC1, PD7/TCAP	I _{IN}	_	_	1	βų		
Capacitance Ports (Input or Output) RESET, IRQ, PD5, PD7/TCAP	C _{out} C _{IN}		_	12 8	pF pF		

Table 9-4. DC Electrical Characteristics (V_{DD} = 3.3 Vdc 10%)

1. Typical values at midpoint of voltage range, 25 C only.

2. Run (operating) I_{DD} measured using external square wave clock source ($f_{OSC} = 2.1$ MHz). All inputs 0.2 V from rail. No dc loads. Less than 50 pF on all outputs. C_L = 20 pF on OSC2.

3. WAIT I_{DD} measured using external square wave clock source ($f_{OSC} = 2.1$ MHz). All inputs 0.2 V from rail. No dc loads. Less than 50 pF on all outputs. C_L = 20 pF on OSC2. All ports configured as inputs. V_{IL} = 0.2 V. V_{IH} = V_{DD} - 0.2 V. OSC2 capacitance linearly affects WAIT I_{DD}. 4. STOP I_{DD} measured with OSC1 = V_{SS}. All ports configured as inputs. V_{IL} = 0.2 V. V_{IH} = V_{DD} - 0.2 V.



The following figures replace Figure 9-2 and Figure 9-3 of MC68HC05P4 Technical Data.

NOTES:

1. Shaded area indicates variation in driver characteristics due to changes in temperature and for normal processing tolerances. Within the limited range of values shown, V vs I curves are approximately straight lines.

2. At V_{DD} = 5.0 V, devices are specified and tested for V_{DH} \ge V_{DD} - 800 mV @ I_{DH} = -0.8 mA.

3. At V_{DD} = 3.3 V, devices are specified and tested for V_{DH} \ge V_{DD} - 300 mV @ I_{DH} = -0.2 mA.





NOTES:

1. Shaded area indicates variation in driver characteristics due to changes in temperature and for normal processing tolerances. Within the limited range of values shown, V vs I curves are approximately straight lines.

2. At V_{DD} = 5.0 V, devices are specified and tested for V_{DL} \leq 400 mV @ I_{DL} = 1.6 mA.

3. At V_{DD} = 3.3 V, devices are specified and tested for V_{OL} \leq 300 mV @ I_{OL} = 0.4 mA.



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The following figures replace Figure 9-4 and Figure 9-5 in MC68HC04P4 Technical Data.

Figure 9-4. Typical Supply Current vs Internal Clock Frequency



Figure 9-5. Maximum Supply Current vs Internal Clock Frequency

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APPENDIX A MC68HCL05P4

This appendix introduces the MC68HCL05P4, a low-power version of the MC68HC05P4. All of the information in *MC68HC05P4 Technical Data* applies to the MC68HCL05P4 with the exceptions given in this appendix.

A.1 DC ELECTRICAL CHARACTERISTICS

The data given in Table 9-3 and Table 9-4 of *MC68HC05P4 Technical Data* applies to the MC68HCL05P4 with the exceptions given in **Table A-1**, **Table A-2**, and **Table A-3**.

Characteristic	Symbol	Min	Тур	Max	Unit
Output High Voltage (I _{LOAD} = -0.1 mA) PA7-PA0, PB7-PB5, PC7-PC0, PD5, TCMP	V _{OH}	V _{DD} - 0.3	_	_	V
Output Low Voltage (I _{LOAD} = 0.2 mA) PA7–PA0, PB7–PB5, PC7–PC0, PD5, TCMP	V _{OL}	_		0.3	V

Characteristic	Symbol	Min	Тур	Max	Unit
Output High Voltage (I _{LOAD} = -0.2 mA) PA7–PA0, PB7–PB5, PC5–PC0, PD5, TCMP	V _{OH}	V _{DD} - 0.3	_	_	V
Output Low Voltage (I _{LOAD} = 0.4 mA) PA7–PA0, PB7–PB5, PC5–PC0, PD5, TCMP	V _{OL}	_		0.3	V

Table A-3. Low-Power	Supply Current
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Characteristic	Symbol	Min	Typ ⁽¹⁾	Max	Unit
Supply Current (V _{DD} = 4.5–5.5 Vdc, f_{OP} = 2.1 MHz) Run ⁽²⁾ WAIT ⁽³⁾ STOP ⁽⁴⁾ 25 C 0 C to 70 C (Standard)	I _{DD}		3.1 1.1 2.0	4.25 2.25 15 25	mA mA μA
$\label{eq:standard} \begin{array}{ c c c } \hline Supply Current (V_{DD} = 2.5 - 3.6 \ \text{Vdc}, \ f_{OP} = 1.0 \ \text{MHz}) \\ \hline Run^{(2)} \\ WAIT^{(3)} \\ STOP^{(4)} \\ 25 \ \text{C} \\ 0 \ \text{C to 70 C (Standard)} \end{array}$	I _{DD}	 	0.8 0.35 0.6 —	1.6 1.0 5.0 10.0	mA mA μΑ μΑ
$ \begin{array}{l} \mbox{Supply Current (V_{DD} = 2.5 - 3.6 Vdc, f_{OP} = 500 \ \mbox{kHz}) \\ \mbox{Run}^{(2)} \\ \mbox{WAIT}^{(3)} \\ \mbox{STOP}^{(4)} \\ \mbox{25 C} \\ \mbox{0 C to 70 C (Standard)} \end{array} $	I _{DD}	 	400 200 0.6 —	800 500 5.0 10.0	А А А А
$ \begin{array}{c} \mbox{Supply Current (V_{DD} = 1.8-2.4 \ Vdc, f_{OP} = 500 \ kHz) \\ \mbox{Run}^{(2)} \\ \mbox{WAIT}^{(3)} \\ \mbox{STOP}^{(4)} \\ \mbox{25 C} \\ \mbox{0 C to 70 C (Standard)} \end{array} $	I _{DD}	 	300 200 0.3 —	600 400 2.0 5.0	А А А А

1. Typical values reflect average measurements at midpoint of voltage range at 25 C.

2. Run (operating) I_{DD} measured using external square wave clock source with all inputs 0.2 V from rail. No dc

loads. Less than 50 pF on all outputs. $C_L = 20$ pF on OSC2. 3. WAIT I_{DD} measured using external square wave clock source with all inputs 0.2 V from rail. No dc loads. Less than 50 pF on all outputs. $C_L = 20$ pF on OSC2. All ports configured as inputs. $V_{IL} = 0.2$ V, $V_{IH} = V_{DD} - 0.2$ V. OSC2 capacitance linearly affects WAIT I_{DD} . 4. STOP I_{DD} measured with OSC1 = V_{DD} . All ports configured as inputs. V_{IL} = 0.2 V, V_{IH} = V_{DD} - 0.2 V.



Figure A-1. Maximum Run Mode $I_{\mbox{\scriptsize DD}}$ vs Frequency



Figure A-2. Maximum WAIT Mode \mathbf{I}_{DD} vs Frequency

A.2 MC Ordering Information

Table A-4 provides information for available package types.

Table A-4. MC Order Numbers

Package Type	Temperature	MC Order Number
28-Pin Plastic Dual In-Line Package (DIP)	0 C to +70 C	MC68HCL05P4P
28-Pin Small Outline Integrated Circuit (SOIC)	0 C to +70 C	MC68HCL05P4DW

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APPENDIX B MC68HSC05P4

This appendix introduces the MC68HSC05P4, a high-speed version of the MC68HC05P4. All of the information in MC68HC05P4 Technical Data applies to the MC68HSC05P4 with the exceptions given in this appendix.

B.1 DC ELECTRICAL CHARACTERISTICS

The data in Table 9-3 and Table 9-4 of MC68HC05P4 Technical Data applies to the MC68HSC05P4 with the exceptions given in Table B-1.

Characteristic	Symbol	Min	Typ ⁽¹⁾	Max	Unit
Supply Current (V _{DD} = 4.5–5.5 Vdc, f_{OP} = 4.0 MHz) Run ⁽²⁾ WAIT ⁽³⁾ STOP ⁽⁴⁾ 25 C -40 to +85 C	I _{DD}	 	7.0 2.0 2.0	9.0 5.0 15 28	mA mA μA μA
$ \begin{array}{l} \mbox{Supply Current (V_{DD} = 3.0-3.6 Vdc, f_{OP} = 2.1 MHz)} \\ \mbox{Run}^{(2)} \\ \mbox{WAIT}^{(3)} \\ \mbox{STOP}^{(4)} \\ \mbox{25 C} \\ \mbox{-40 to +85 C} \end{array} $	I _{DD}		1.8 0.8 0.6 —	5.0 2.5 5.0 12	mA mA μA μA

Table B-1. High-Speed Supply Current

1. Typical values at midpoint of voltage range, 25 C only.

2. Run (operating) I_{DD} measured using external square wave clock source with all inputs 0.2 V from rail. No dc loads. Less than 50 pF on all outputs. $C_1 = 20$ pF on OSC2.

3. WAIT I_{DD} measured using external square wave clock source with all inputs 0.2 V from rail. No dc loads. Less than 50 pF on all outputs. $C_L = 20$ pF on OSC2. All ports configured as inputs; $V_{IL} = 0.2$ V, $V_{IH} = V_{DD} - 0.2$ V. OSC2 capacitance linearly affects WAIT I_{DD} . 4. STOP I_{DD} measured with OSC1 = V_{DD} . All ports configured as inputs. V_{IL} = 0.2 V, V_{IH} = V_{DD} - 0.2 V.

B.2 CONTROL TIMING

The data given in Table 9-5 and Table 9-6 of *MC68HC05P4 Technical Data* applies to the MC68HSC05P4 with the exceptions given in **Table B-2** and **Table B-3**.

Characteristic	Symbol	Min	Max	Unit
Oscillator Frequency Crystal Oscillator External Clock	f _{osc}	dc	8.0 8.0	MHz MHz
Internal Operating Frequency (f _{osc} Ö2) Crystal Oscillator External Clock Option	f _{OP}	dc	4.0 4.0	MHz MHz
Internal Clock Cycle Time	t _{cyc}	250		ns
Capture/Compare Timer Input Capture Pulse Width	t _{TH} , t _{TL}	63		ns
Interrupt Pulse Width Low (Edge-Triggered)	t _{ILIL}	63		ns
OSC1 Pulse Width	t _{OH} , t _{OL}	45		ns

Table B-2. High-Speed Control Timing (V_{DD} = 5.0 V 10%)

Table D. 2. Lligh Created Control Timing (V. 2.2.V.	400/)
Table B-3. High-Speed Control Timing (V _{DD} = 3.3 V	10%)

Characteristic	Symbol	Min	Max	Unit
Oscillator Frequency Crystal Oscillator External Clock	f _{osc}	dc	4.2 4.2	MHz MHz
Internal Operating Frequency (f _{OSC} Ö2) Crystal Oscillator External Clock Option	f _{OP}	dc	2.1 2.1	MHz MHz
Internal Clock Cycle Time	t _{cyc}	480		ns
Capture/Compare Timer Input Capture Pulse Width	t _{TH} , t _{TL}	125		ns
Interrupt Pulse Width Low (Edge-Triggered)	t _{ILIL}	125		ns
OSC1 Pulse Width	t _{oH} , t _{oL}	90		ns

B.3 SIOP TIMING

The data given in Table 9-7 and Table 9-8 of *MC68HC05P4 Technical Data* applies to the MC68HSC05P4 with the exceptions given in **Table B-4** and **Table B-5**.

Characteristic	Symbol	Min	Max	Unit
Clock (SCK) Low Time (f _{OP} = 4.2 MHz)	t _{SCKL}	466	—	ns
SDO Data Valid Time	t _v	—	100	ns
SDO Hold Time	t _{HO}	0	—	ns
SDI Setup Time	t _s	50	—	ns
SDI Hold Time	t _H	50	—	ns

Table B-4. SIOP Timing ($V_{DD} = 5.0 \text{ V}$ 10%)

Table B-5. SIOP Timing ((V _{DD} = 3.3 V	10%)
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Characteristic	Symbol	Min	Max	Unit
Clock (SCK) Low Time (f _{OP} = 2.1 MHz)	t _{SCKL}	990	—	ns
SDO Data Valid Time	t _v	—	200	ns
SDO Hold Time	t _{HO}	0	—	ns
SDI Setup Time	t _s	100	—	ns
SDI Hold Time	t _H	100	—	ns

B.4 MC ORDERING INFORMATION

Table B-6 provides information for available package types.

Table B-6. MC Order Numbers

Package Type	Temperature	MC Order Number
28-Pin Plastic Dual In-Line Package (DIP)	0 C to +70 C -40 C to +85 C	MC68HSC05P4P MC68HSC05P4CP
28-Pin Small Outline Integrated Circuit (SOIC)	0 C to +70 C -40 C to +85 C	MC68HSC05P4DW MC68HSC05P4CDW

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